PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Masaki Kanazawa	01/28/2009
Hajime Akahori	01/28/2009

RECEIVING PARTY DATA

Name:	Tokyo Seimitsu Co., Ltd.	
Street Address:	7-1, Shimorenjaku 9-chome	
City:	Mitaka-shi, Tokyo	
State/Country:	JAPAN	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12360610

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	63380/A400
NAME OF SUBMITTER:	D. Bruce Prout

Total Attachments: 1

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CH \$40.00

PATENT REEL: 022215 FRAME: 0472

U.S. ASSIGNMENT

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter "ASSIGNOR") by

(Insert ASSIGNEE's Name(s) Address(es))	7-1, Shimorenjaku 9-chome, Mitaka-shi, Tokyo, Japan					
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	(hereinafter "ASSIGNEE"), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest to the invention entitled					
(Title of Invention)	WAFER PROCESSING METHOD	FOR PROCESSING WAFE	R HAVING BUMPS FORMED THEREON			
	relating to International Patent Application of the United States was executed on ever	on PCT/JP/ n date herewith or, if not so execut	and/or for which application for Letters Patent ted, was:			
(Insert date of execution of application, if not concurrent)	(a) executed on	Assignee's attorney is h data, when known.	erêby authorized to insert in (b) the specified			
	and to said application and all Letters Patent(s) of the United States granted on said application and any continuation, division, renewal, substitute, reissue or reexamination application based thereon, for the full term or terms for which the said Letters Patent(s) may be granted and including any extensions thereof (collectively, hereinafter, *said application(s) and Letters Patent(s)*).					
	The ASSIGNOR agree(s), when requested by said ASSIGNEE and without charge to but at the expense of said ASSIGNEE, to do all acts which the ASSIGNEE may deem necessary, desirable or expedient, for securing, maintaining and enforcing protection for said invention, including in the preparation and prosecution of said application(s) and the issuance of said Letters Patent(s), in any interference, reissue, reexamination, or public use proceeding, and in any litigation or other legal proceeding which may arise or be declared in relation to same, such acts to include but not be limited to executing all papers, including separate assignments and declarations, taking all rightful oaths, providing sworn testimony, and obtaining and producing evidence.					
	IN WITNESS WHEREOF, the un	ndersigned inventor(s) has (have) a	offixed his/her/their signature(s).			
(Signatures)	1) 恒持 雅亳	Masaki Kanazawa	January 28, 2009			
	(SIGNATURE)	(TYPE NAME)	(DATE)			
	2)	Hajime Akahori (TYPE NAME)	January 28, 2009 (DATE)			
	3)(SIGNATURE)	(TYPE NAME)	(DATE)			
	4)(SIGNATURE)	(TYPE NAME)	(DATE)			
	5)(SIGNATURE)	(TYPE NAME)	(DATE)			
	6)(SIGNATURE)	(TYPE NAME)	(DATE)			
	7)(SIGNATURE)	(TYPE NAME)	(DATE)			

(TYPE NAME)

RECORDED: 02/05/2009

PATENT REEL: 022215 FRAME: 0473

(DATE)